539.00 EUR
incl. 19% VAT, plus shipping

- New Version 12/22 !

- Intel® Skylake/Kabylake U-Series SoC Processor, Default: 3955U
- 1* 260-pin Dual-channel DDR4 2133MHz SODIMM Up to 16 GB
- 4* Ethernet Ports
- 1* Full size Mini-SATA Socket (SATA + USB Signal)
- 2* Mini PCIe Slots (1* full size, 1* half size)
- 1* SIM card holder
- Supports on board TPM2.0 (option)
- 1* RS232 Console, 2* USB3.0, 2* USB2.0

Model	– HBFDF731-3955-V (Default) – HBFDF731Z-3955-V (Wifi) – HBFDF731-3965-V – HBFDF731Z-3965-V (Wifi)	
CPU/Chipset	– Intel® Skylake/Kabylake U-Series SoC Processor Notes : When the system runs, CPU will automatically adjust its working clock frequency according to changing workload.	
BIOS	– AMI Flash ROM	

Memory	– 1* SO-DIMM DDR4-2133MHz up to 16GB
Network	– 1* Intel® i219LM GbE – 3* Intel® i225V 2.5GbE
Graphics	– Intel® HD Graphics, shared memory – 1* HDMI (Reserve, Max. resolution:4096 x 2304@24Hz)
Storage	– 1* full size mSATA – 1* 2.5” SATAIII Device (support 2.5” HDD with a height ≤ 10mm)
Expansion	– 1* half size Mini PCIe slot (for WiFi expansion) – 1* full size Mini PCIe slot with 1 * SIM card holder
Rear Panel I/O	– 4 * RJ45 (3 * i225V + 1 * i219LM) – 2 * USB3.0 – 1 * HDMI (Reserve, Max. resolution:4096 x 2304@24Hz) – 1 * RS232 – 1 * DC-in jack
Front Panel I/O	– 1 * Power button, 1 * Reset button – 1 * Power LED, 1 * HDD LED – 2 * USB2.0 – 4 * NIC LED – 1 * COM & 1 * GPIO (option)
Internal Connector	– Onboard TPM2.0 (option)
Power Source	– MB: DC-in 12V – Adapter: AC_90~240V / DC_12V_5A / 60W
Compliance	– CE, FCC, LVD Ready
Dimensions	– System: 193 (W) x 142.4 (D) x 62 (H) mm – Box: 250 (W) x 118 (D) x 295 (H) mm
Temperature	– Operating Temperature: -20 ~ 50° C (Under the condition of using mSATA or SSD) – Operating Temperature: 0 ~ 50° C (Under the condition of using 2.5” SATA HDD) (The test environment is closed and windless) – Storage Temperature: -20 ~ 70° C – Humidity: Between 40% and 60%, non-condensing
OS Support	– 32/64 bit versions of Windows 7, Windows 8.1, Windows 10, Linux